

Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-20	V
Collector-Emitter Voltage	V _{CEO}	-20	V
Emitter-Base Voltage	V _{EBO}	-7	V
Peak Pulse Collector Current	I _{CM}	-3	А
Continuous Collector Current	Ic	-2	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 5)	D	600	mW	
Power Dissipation	(Note 6)	P _D	1.2	W	
Thermal Desigtance Junction to Ambient Air	(Note 5)	D	209		
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{ heta JA}$	104	°C/W	
Thermal Resistance, Junction to Leads	(Note 7)	$R_{ heta JL}$	75		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	٧	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted on minimum recommended pad layout with 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as note 5, except mounted on 25mm x 25mm 1oz copper.7. Thermal resistance from junction to solder-point (at the end of collector lead).
- 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating information

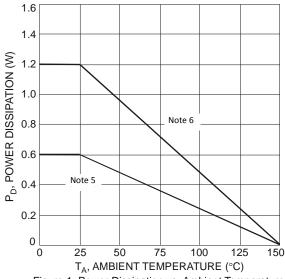
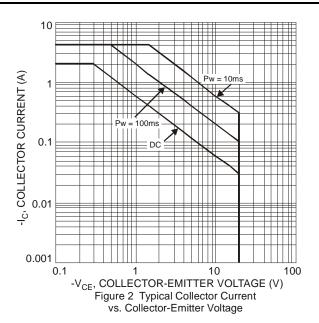
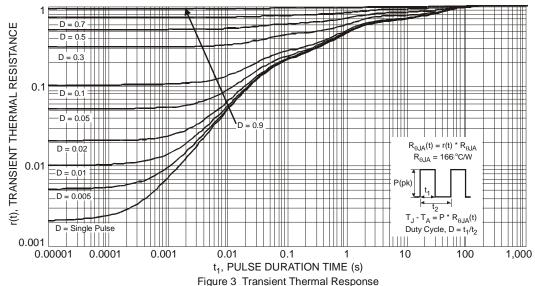


Figure 1 Power Dissipation vs. Ambient Temperature







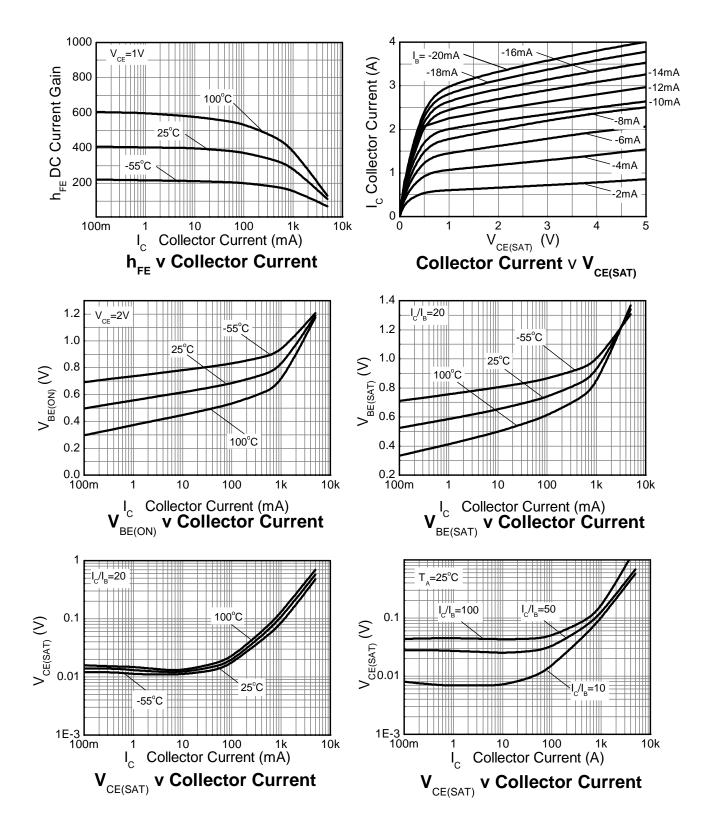
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-20	_	_	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-20	_	_	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	_	_	V	I _E = -100μA
Collector-Base Cutoff Current		_	_	-100	nA	$V_{CB} = -20V, I_{E} = 0$
	I _{CBO}			-50	μΑ	$V_{CB} = -20V, I_{E} = 0, T_{J} = +150^{\circ}C$
Emitter-Base Cutoff Current	I _{EBO}	_	_	-100	nA	$V_{EB} = -6V, I_{C} = 0$
ON CHARACTERISTICS (Note 9)						
DC Current Gain		225	_	_		$V_{CE} = -2V, I_{C} = -100mA$
	b	225	_	_		$V_{CE} = -2V, I_{C} = -500mA$
	h _{FE}	200	_	_		$V_{CE} = -2V, I_{C} = -1A$
		150	_	_		$V_{CE} = -2V, I_{C} = -2A$
		_	_	-80	- mV	$I_C = -500 \text{mA}, I_B = -50 \text{mA}$
Collector-Emitter Saturation Voltage	V	_	_	-150		$I_C = -1A$, $I_B = -50mA$
Conector-Emitter Saturation Voltage	V _{CE(SAT)}	_	_	-250		$I_C = -2A$, $I_B = -100mA$
		_	_	-225		$I_C = -2A$, $I_B = -200mA$
Equivalent On-Resistance	R _{CE(SAT)}	_	_	113	mΩ	$I_C = -2A$, $I_B = -200mA$
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	_	-1.1	V	$I_C = -2A$, $I_B = -100mA$
Base-Emitter Turn-on Voltage	V _{BE(ON)}	_	_	-1.2	V	$V_{CE} = -2V, I_{C} = -1A$
SMALL SIGNAL CHARACTERISTICS						
Transition Frequency	ft	100	_	_	MHz	V _{CE} = -5V, I _C = -100mA, f = 100MHz
Collector-Base Capacitance	C _{cbo}	_	_	50	pF	V _{CB} = -10V, f = 1MHz

Note: 9. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

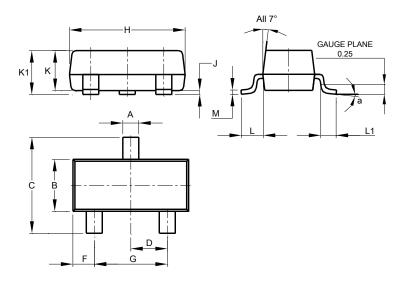




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

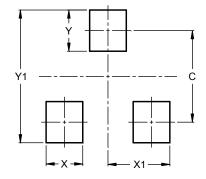


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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